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AMENDMENT UNDER 37 C.F.R. § 1.116 EXPEDITED PROCEDURE GROUP 2841 PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Docket No: Q92997

Yasukazu NAKATA, et al.

Appln. No.: 10/567,358

Group Art Unit: 2841

Confirmation No.: 9855

Examiner: Dameon E. LEVI

Filed: February 6, 2006

For:

FLIP CHIP MOUNTING SUBSTRATE

AMENDMENT UNDER 37 C.F.R. § 1.116

MAIL STOP AF

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In response to the Office Action dated May 23, 2007, please amend the above-identified application as follows on the accompanying pages.

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